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# HD74HC353

Dual 4-to-1-line Data Selectors/Multiplexers (with 3-state outputs)

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## Description

Each of these data selectors/multiplexers contains inverters and drivers to supply full binary decoding data selection to the AND-OR-invert gates. Separate strobe inputs (G) are provided for each of the two four-line sections.

The three-state outputs can interface with and drive data lines of bus-organized systems. With all but one of the common output disabled (at a high-impedance state) the low-impedance of the single enable output will drive the bus line to a high or low logic level. Each output has its own strobe (G). The output is disabled when its strobe is high.

## Features

- High Speed Operation:  $t_{pd}$  (Data to Y) = 13 ns typ ( $C_L = 50$  pF)
- High Output Current: Fanout of 10 LSTTL Loads
- Wide Operating Voltage:  $V_{CC} = 2$  to 6 V
- Low Input Current: 1  $\mu$ A max
- Low Quiescent Supply Current:  $I_{CC}$  (static) = 4  $\mu$ A max ( $T_a = 25^\circ\text{C}$ )

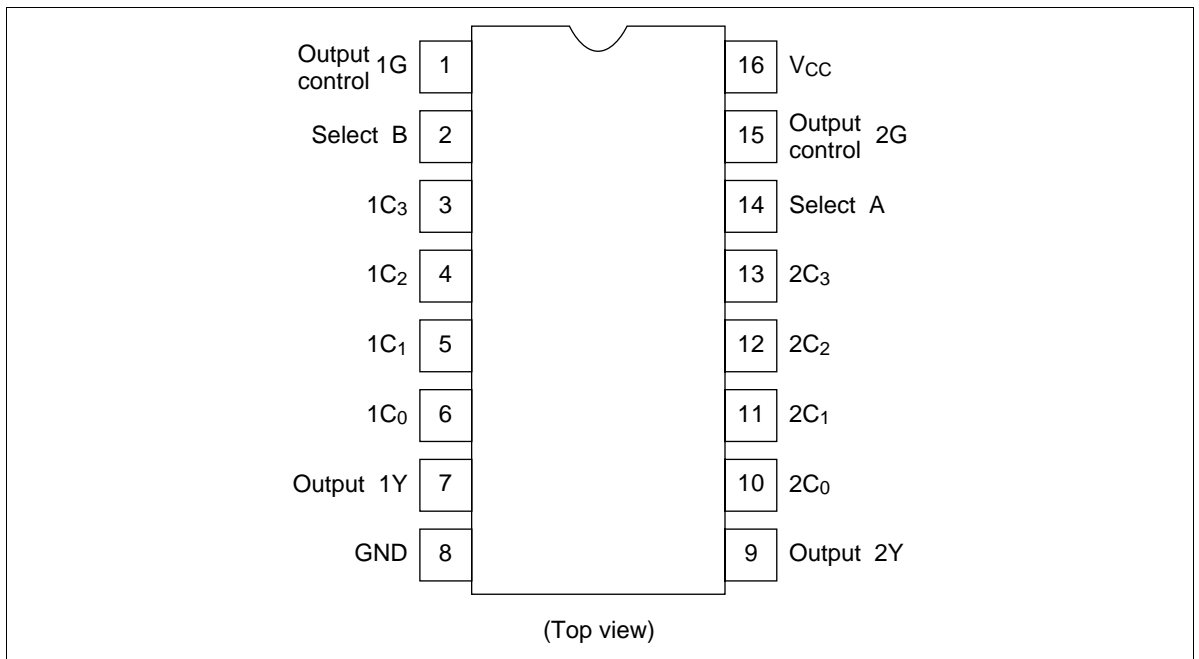
# HD74HC353

## Function Table

Select Input		Data Inputs				Output Control	Output
B	A	C <sub>0</sub>	C <sub>1</sub>	C <sub>2</sub>	C <sub>3</sub>	G	Y
X	X	X	X	X	X	H	Z
L	L	L	X	X	X	L	H
L	L	H	X	X	X	L	L
L	H	X	L	X	X	L	H
L	H	X	H	X	X	L	L
H	L	X	X	L	X	L	H
H	L	X	X	H	X	L	L
H	H	X	X	X	L	L	H
H	H	X	X	X	H	L	L

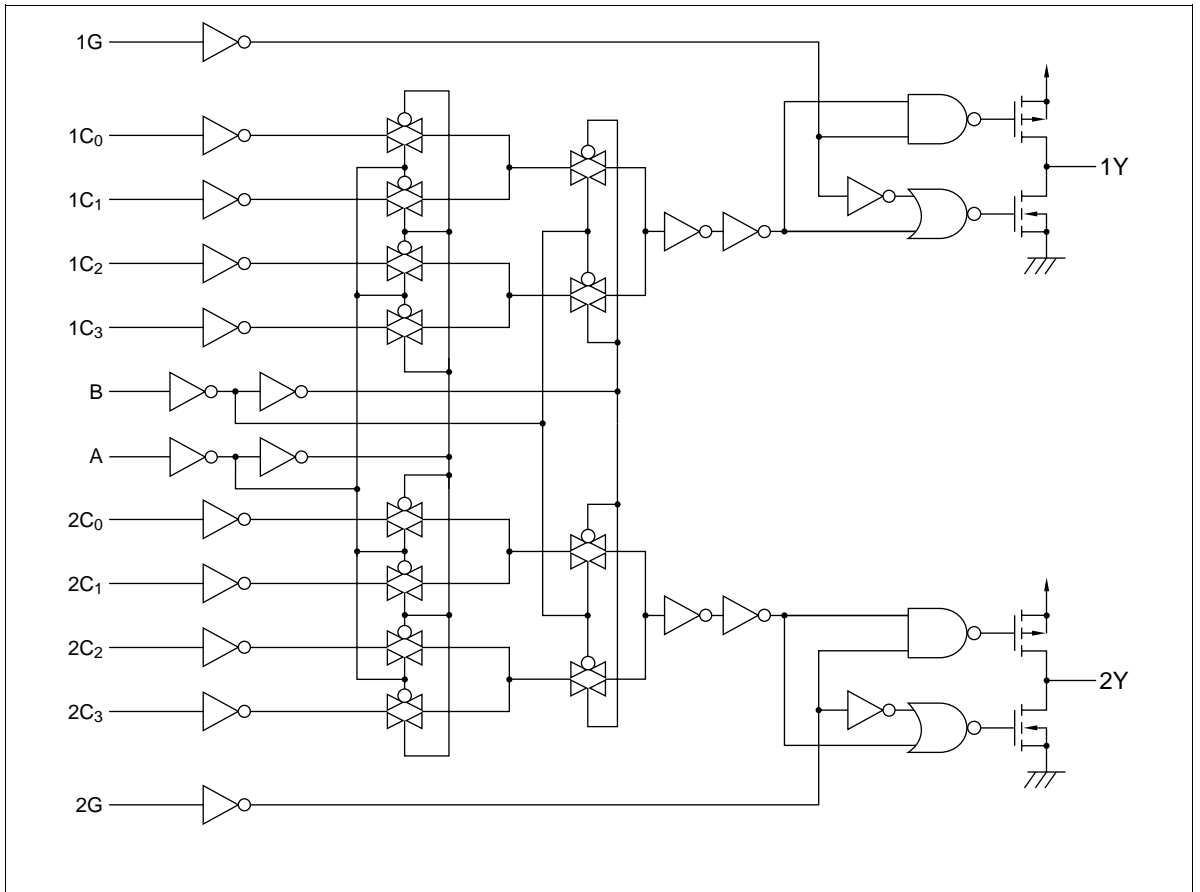
Select inputs A and B are common to both sections

## Pin Arrangement



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Logic Diagram

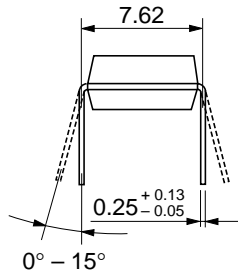
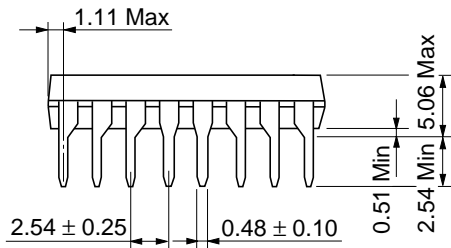
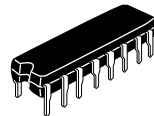
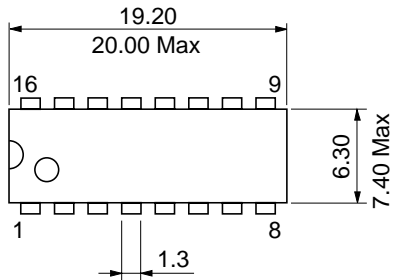


## DC Characteristics

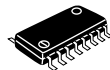
Item	Symbol	V <sub>CC</sub> (V)	Ta = 25°C			Ta = -40 to +85°C		Unit	Test Conditions	
			Min	Typ	Max	Min	Max			
Input voltage	V <sub>IH</sub>	2.0	1.5	—	—	1.5	—	V		
		4.5	3.15	—	—	3.15	—			
		6.0	4.2	—	—	4.2	—			
	V <sub>IL</sub>	2.0	—	—	0.5	—	0.5			V
		4.5	—	—	1.35	—	1.35			
		6.0	—	—	1.8	—	1.8			
Output voltage	V <sub>OH</sub>	2.0	1.9	2.0	—	1.9	—	V	Vin = V <sub>IH</sub> or V <sub>IL</sub> I <sub>OH</sub> = -20 μA	
		4.5	4.4	4.5	—	4.4	—			
		6.0	5.9	6.0	—	5.9	—			
		4.5	4.18	—	—	4.13	—			I <sub>OH</sub> = -4 mA
		6.0	5.68	—	—	5.63	—			I <sub>OH</sub> = -5.2 mA
	V <sub>OL</sub>	2.0	—	0.0	0.1	—	0.1	V	Vin = V <sub>IH</sub> or V <sub>IL</sub> I <sub>OL</sub> = 20 μA	
		4.5	—	0.0	0.1	—	0.1			
		6.0	—	0.0	0.1	—	0.1			
		4.5	—	—	0.26	—	0.33			I <sub>OL</sub> = 4 mA
		6.0	—	—	0.26	—	0.33			I <sub>OL</sub> = 5.2 mA
Input current	I <sub>in</sub>	6.0	—	—	±0.1	—	±1.0	μA	Vin = V <sub>CC</sub> or GND	
Quiescent supply current	I <sub>CC</sub>	6.0	—	—	4.0	—	40	μA	Vin = V <sub>CC</sub> or GND, I <sub>out</sub> = 0 μA	

AC Characteristics ( $C_L = 50$  pF, Input  $t_r = t_f = 6$  ns)

Item	Symbol	$V_{CC}$ (V)	Ta = 25°C		Ta = -40 to +85°C		Unit	Test Conditions		
			Min	Typ	Max	Min			Max	
Propagation delay time	$t_{PLH}$	2.0	—	—	125	—	155	ns	Data to Y	
	$t_{PHL}$	4.5	—	13	25	—	31			
		6.0	—	—	21	—	26			
			2.0	—	—	160	—	200	ns	A or B to Y
			4.5	—	14	32	—	40		
			6.0	—	—	27	—	34		
Output enable time	$t_{ZL}$	2.0	—	—	100	—	125	ns		
	$t_{ZH}$	4.5	—	8	20	—	25			
		6.0	—	—	17	—	21			
Output disable time	$t_{LZ}$	2.0	—	—	150	—	190	ns		
	$t_{HZ}$	4.5	—	11	30	—	38			
		6.0	—	—	26	—	33			
Output rise/fall time	$t_{TLH}$	2.0	—	—	75	—	95	ns		
	$t_{THL}$	4.5	—	5	15	—	19			
		6.0	—	—	13	—	16			
Input capacitance	$C_{in}$	—	—	5	10	—	10	pF		



Hitachi Code	DP-16
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	1.07 g



\*Dimension including the plating thickness  
Base material dimension

Hitachi Code	FP-16DA
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.24 g



\*Dimension including the plating thickness  
Base material dimension

Hitachi Code	FP-16DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.15 g



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